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# FQP7N20

### 200V N-Channel MOSFET

## **General Description**

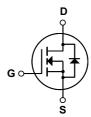
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply, DC-AC converters for uninterrupted power supply, motor control.

### **Features**

- 6.6A, 200V,  $R_{DS(on)}$  = 0.69 $\Omega$  @V<sub>GS</sub> = 10 V Low gate charge ( typical 8.0 nC)
- Low Crss (typical 9.0 pF)
- · Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability





# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQP7N20	Units
V <sub>DSS</sub>	Drain-Source Voltage		200	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C	C)	6.6	Α
	- Continuous (T <sub>C</sub> = 100°	(C)	4.2	Α
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	26	Α
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	73	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	6.6	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	6.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)		63	W
	- Derate above 25°C		0.51	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

# **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.98	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C		0.27		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V			1	μΑ
		V <sub>DS</sub> = 160 V, T <sub>C</sub> = 125°C			10	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.3 A		0.55	0.69	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 3.3 A (Note 4)		4.0		S
C <sub>oss</sub>	Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		60 9	75 12	pF pF
C <sub>oss</sub>	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz				
						ρ.
Switch	ing Characteristics					Pi
	ing Characteristics Turn-On Delay Time	V - 100 V I - 6 6 A		8	25	ns
t <sub>d(on)</sub>		V <sub>DD</sub> = 100 V, I <sub>D</sub> = 6.6 A,		8 65	25 140	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 100 \text{ V}, I_{D} = 6.6 \text{ A},$ $R_{G} = 25 \Omega$		_		ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time Turn-On Rise Time			65	140	ns ns
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time	$R_G$ = 25 Ω (Note 4, 5)		65 15	140 40	ns ns
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$R_G = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 \text{ V}, I_D = 6.6 \text{ A},$		65 15 35	140 40 80	ns ns ns
$\begin{array}{c} t_{d(on)} \\ t_r \\ \\ t_{d(off)} \\ \\ t_f \\ \\ Q_g \\ \\ Q_{gs} \end{array}$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$R_G$ = 25 Ω (Note 4, 5)		65 15 35 8.0	140 40 80 10	ns ns ns ns
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \\ Q_g \\ \\ Q_{gs} \\ \\ Q_{gd} \\ \end{array}$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$R_{G} = 25 \ \Omega$ (Note 4, 5) $V_{DS} = 160 \ V, \ I_{D} = 6.6 \ A,$ $V_{GS} = 10 \ V$ (Note 4, 5)	  	65 15 35 8.0 2.4	140 40 80 10	ns ns ns ns
$\begin{array}{c} t_{d(\text{on})} \\ t_{r} \\ t_{d(\text{off})} \\ \end{array}$ $\begin{array}{c} t_{f} \\ Q_{g} \\ Q_{gs} \\ Q_{gd} \\ \end{array}$ $\begin{array}{c} Drain-S \\ \end{array}$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$R_{G} = 25~\Omega \label{eq:RG}$ (Note 4, 5) $V_{DS} = 160~V,~I_{D} = 6.6~A,~V_{GS} = 10~V \label{eq:RG}$ (Note 4, 5) and Maximum Ratings	  	65 15 35 8.0 2.4	140 40 80 10 	ns ns ns ns nC nC
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \\ \textbf{Drain-S} \\ I_S \\ \end{array}$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge  Source Diode Characteristics and Maximum Continuous Drain-Source Diode	$R_G = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 \text{ V}, I_D = 6.6 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 4, 5) and Maximum Ratings of Forward Current	    	65 15 35 8.0 2.4 3.3	140 40 80 10  	ns ns ns ns nC nC
$\begin{aligned} & \overset{t_{d(on)}}{t_r} \\ & \overset{t_{d(off)}}{t_f} \\ & \overset{Q_g}{Q_{gs}} \\ & \overset{Q_{gd}}{Drain-S} \\ & \overset{I_S}{I_{SM}} \end{aligned}$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge  Source Diode Characteristics as Maximum Continuous Drain-Source Diode Fall Time	$R_{G}$ = 25 $\Omega$ (Note 4, 5) $V_{DS}$ = 160 V, $I_{D}$ = 6.6 A, $V_{GS}$ = 10 V (Note 4, 5)  and Maximum Ratings  ode Forward Current  Forward Current	   	65 15 35 8.0 2.4 3.3	140 40 80 10   6.6 26	ns ns ns nc nC nC A A
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \\ \textbf{Drain-S} \\ I_S \\ \end{array}$	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge  Source Diode Characteristics and Maximum Continuous Drain-Source Diode	$R_G = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 \text{ V}, I_D = 6.6 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 4, 5) and Maximum Ratings of Forward Current	    	65 15 35 8.0 2.4 3.3	140 40 80 10  	ns ns ns ns nC nC

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 2.5mH, I<sub>AS</sub> = 6.6A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 Ω, Starting T<sub>J</sub> = 25°C 3. I<sub>SD</sub>  $\leq$  6.6A, di/dt  $\leq$  300A/μs, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C 4. Pulse Test : Pulse width  $\leq$  300μs, Duty cycle  $\leq$  2% 5. Essentially independent of operating temperature

# **Typical Characteristics**

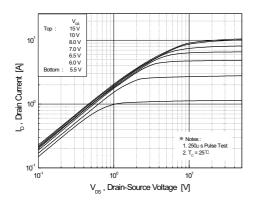


Figure 1. On-Region Characteristics

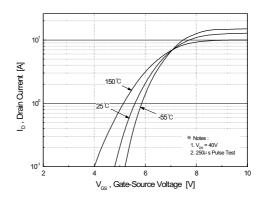


Figure 2. Transfer Characteristics

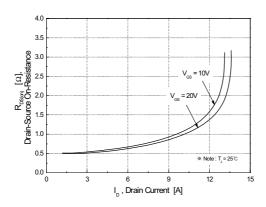


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

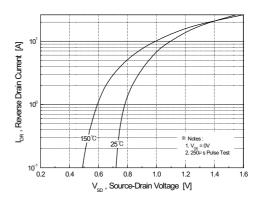


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

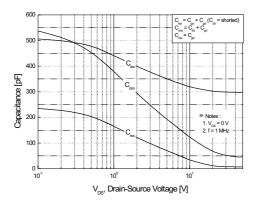


Figure 5. Capacitance Characteristics

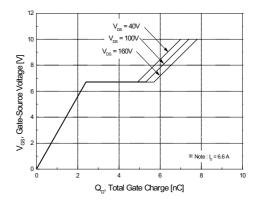
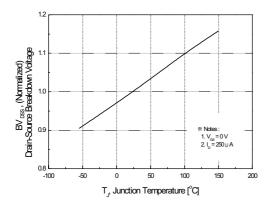


Figure 6. Gate Charge Characteristics

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# Typical Characteristics (Continued)



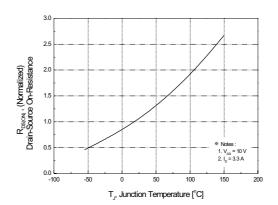
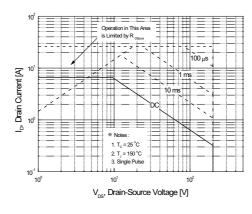


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



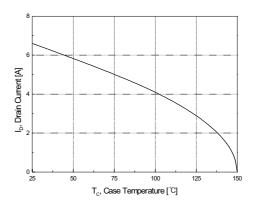


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

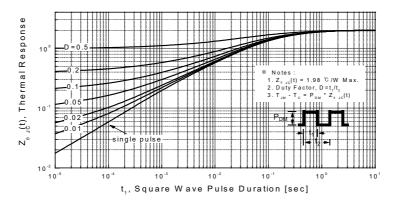
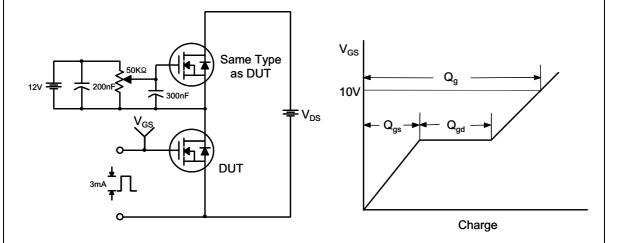


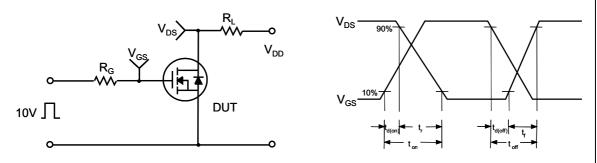
Figure 11. Transient Thermal Response Curve

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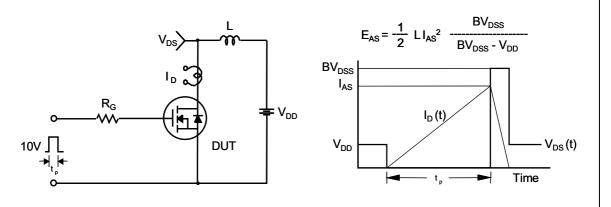
# **Gate Charge Test Circuit & Waveform**



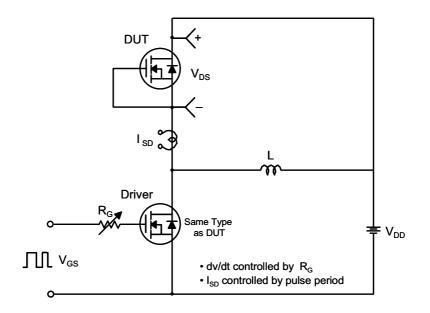
# **Resistive Switching Test Circuit & Waveforms**

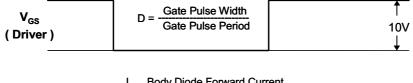


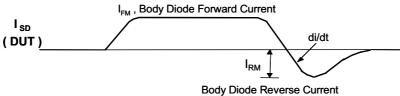
# **Unclamped Inductive Switching Test Circuit & Waveforms**

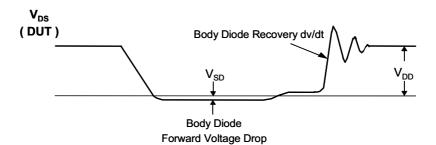


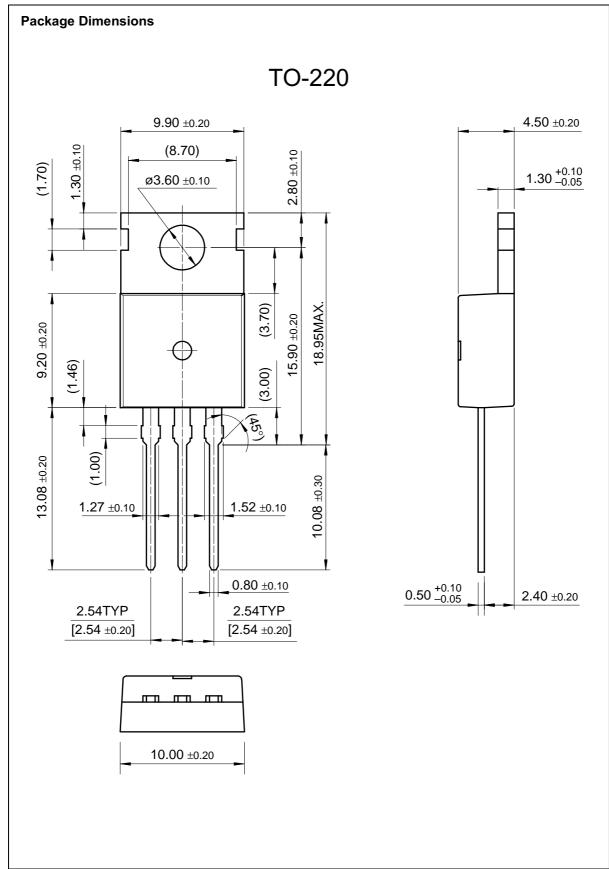
### Peak Diode Recovery dv/dt Test Circuit & Waveforms











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